



REVISIONS				
REV.	BY	DESCRIPTION	DATE	APPROVED
C		INITIAL RELEASE	APR18/06	ML
D		PCB SOLDER PAD WIDTHS RED FROM .010" TO .014"	SEP18/07	SL
E		TOLERANCE ADDED TO PCB HOLE LOCATING PIN	SEP27/07	SL
F		FSI-R26-3000 ADDED	APR03/07	SL
G		DRUM PRT DIMS ADDED, TOLERANCE ADDED TO .472	AUG18/07	SL
H		KEYINGS MOVED	AUG23/07	SL
J		IMPREG LINE REMOVED	OCT4/07	SL

PART NUMBER	PACKAGING	CONTACT PLATING
FS1-R26-2000	TAPE AND REEL	30µ" GOLD OVER 50µ" NICKEL IN CONTACT AREAS 100µ" MATTE TIN OVER 50µ" NICKEL IN SOLDER AREAS
FS1-R26-3000		15µ" GOLD OVER 50µ" NICKEL IN CONTACT AREAS 100µ" MATTE TIN OVER 50µ" NICKEL IN SOLDER AREAS

- NOTES
- MATERIAL
HOUSING: SOLDER REFLOW PROCESS COMPATIBLE LCP, UL94V-0
CONTACTS: PHOSPHOR BRONZE
 - ROHS COMPLIANT
 - PERFORMANCE
ELECTRICAL: 0.5 AMPS MAX. PER CONTACT
MECHANICAL: 250 MATING CYCLES MINIMUM
 - COMPLIES WITH SPF-8086



KEEP OUT ZONE IN HATCHED AREAS
NO TRACES OR INK MARKING ALLOWED

DO NOT SCALE DRAWING

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UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS TOLERANCES ARE:	APPROVALS	DATE	Amphenol Canada Corp.
DRW: MAB	DRW: YK	15/FEB/06	REV:
XX ± 0.25 ± 2°	CHK: YK	15/FEB/06	APP:
XX ± 0.13	CR: YK		SPF, 26 POSITION CONNECTOR
MA: YK	QA APP:		
ENG: EAR	ELAPP:		REV: C
COLL: 03554	DRG: APP:		REV: NIS
			REV: SPF
			REV: J
			REV: 1 OF 1

RECOMMENDED PCB LAYOUT